



Integrated Device Technology, Inc.

CMOS PARALLEL FIFO 64 x 4-BIT AND 64 x 5-BIT

IDT72401
IDT72402
IDT72403
IDT72404

FEATURES:

- First-In/First-Out dual-port memory
- 64 x 4 organization (IDT72401/03)
- 64 x 5 organization (IDT72402/04)
- IDT72401/02 pin and functionally compatible with MMI67401/02
- RAM-based FIFO with low fall-through time
- Low power consumption
 - Active: 175mW (typ.)
- Maximum shift rate — 45MHz
- High data output drive capability
- Asynchronous and simultaneous read and write
- Fully expandable by bit width
- Fully expandable by word depth
- IDT72403/04 have Output Enable pin to enable output data
- High-speed data communications applications
- High-performance CEMOS™ technology
- Available in CERDIP, plastic DIP and SOIC
- Military product compliant to MIL-STD-883, Class B
- Standard Military Drawing# 5962-86846 and 5962-89523 is listed on this function.

DESCRIPTION:

The IDT72401 and IDT72403 are asynchronous high-performance First-In/First-Out memories organized 64 words by 4 bits. The IDT72402 and IDT72404 are asynchronous high-performance First-In/First-Out memories organized as 64 words by 5 bits. The IDT72403 and IDT72404 also have an

Output Enable (\overline{OE}) pin. The FIFOs accept 4-bit or 5-bit data at the data input (D0-D3, 4). The stored data stack up on a first-in/first-out basis.

A Shift Out (SO) signal causes the data at the next to last word to be shifted to the output while all other data shifts down one location in the stack. The Input Ready (IR) signal acts like a flag to indicate when the input is ready for new data (IR = HIGH) or to signal when the FIFO is full (IR = LOW). The Input Ready signal can also be used to cascade multiple devices together. The Output Ready (OR) signal is a flag to indicate that the output remains valid data (OR = HIGH) or to indicate that the FIFO is empty (OR = LOW). The Output Ready can also be used to cascade multiple devices together.

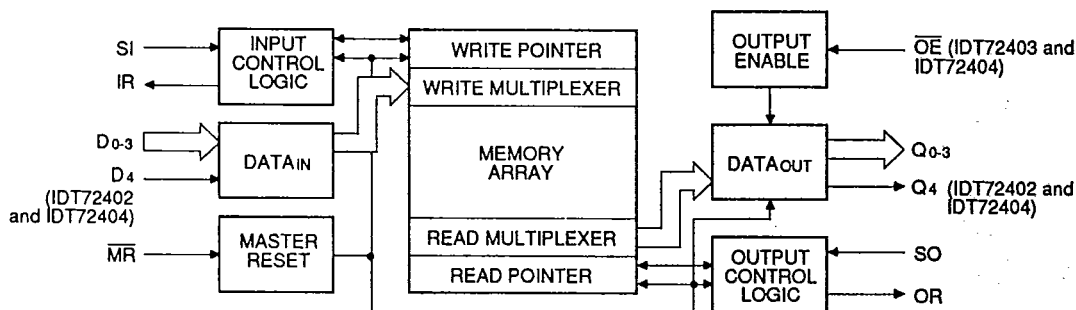
Width expansion is accomplished by logically ANDing the Input Ready (IR) and Output Ready (OR) signals to form composite signals.

Depth expansion is accomplished by tying the data inputs of one device to the data outputs of the previous device. The Input Ready pin of the receiving device is connected to the Shift Out pin of the sending device and the Output Ready pin of the sending device is connected to the Shift In pin of the receiving device.

Reading and writing operations are completely asynchronous allowing the FIFO to be used as a buffer between two digital machines of widely varying operating frequencies. The 45MHz speed makes these FIFOs ideal for high-speed communication and controller applications.

Military grade product is manufactured in compliance with the latest revision of MIL-STD-883, Class B.

FUNCTIONAL BLOCK DIAGRAM



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MILITARY AND COMMERCIAL TEMPERATURE RANGES

AUGUST 1990

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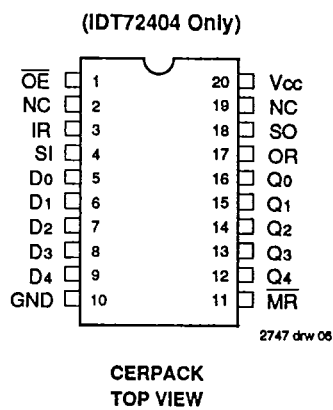
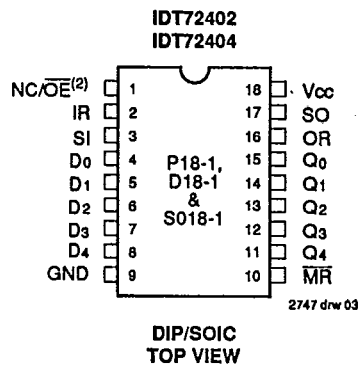
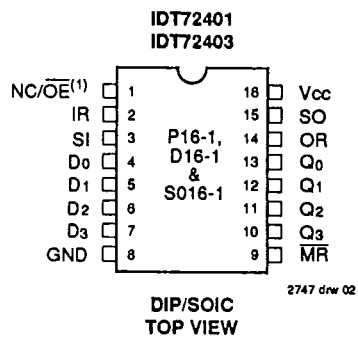
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PIN CONFIGURATIONS



NOTES:

- Pin 1: NC - No Connection IDT72401
OE - IDT72403
- Pin 1: NC - No Connection IDT72402
OE - IDT72404

IDT72401, IDT72402, IDT72403, IDT72404
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ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Rating	Commercial	Military	Unit
VTERM	Terminal Voltage with Respect to GND	-0.5 to +7.0	-0.5 to +7.0	V
TA	Operating Temperature	0 to +70	-55 to +125	°C
TBIAS	Temperature Under Bias	-55 to +125	-65 to +135	°C
TSTG	Storage Temperature	-55 to +125	-65 to +150	°C
IOUT	DC Output Current	50	50	mA

NOTE:

1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min.	Typ.	Max.	Unit
VCC	Military Supply Voltage	4.5	5.0	5.5	V
VCC	Commercial Supply Voltage	4.5	5.0	5.5	V
GND	Supply Voltage	0	0	0	V
V _{IH}	Input High Voltage	2.0	—	—	V
V _{IL} ⁽¹⁾	Input High Voltage	—	—	0.8	V

NOTE:

1. 1.5V undershoots are allowed for 10ns once per cycle.

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CAPACITANCE (TA = +25°C, f = 1.0MHz)

Symbol	Parameter ⁽¹⁾	Conditions	Max.	Unit
C _{IN}	Input Capacitance	V _{IN} = 0V	5	pF
C _{OUT}	Output Capacitance	V _{OUT} = 0V	7	pF

NOTE:

1. This parameter is sampled and not 100% tested.

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DC ELECTRICAL CHARACTERISTICS

(Commercial: VCC = 5.0V ± 10%, TA = 0°C to +70°C; Military: VCC = 5.0V ± 10%, TA = -55°C to +125°C)

Symbol	Parameter	Test Conditions	Min.	Max.	Unit
V _{IC} ⁽¹⁾	Input Clamp Voltage		—	—	—
V _{IL}	Low-Level Input Current	VCC = Max., GND ≤ V _I ≤ VCC	-10	—	μA
V _{IH}	High-Level Input Current	VCC = Max., GND ≤ V _I ≤ VCC	—	10	μA
V _{OL}	Low-Level Output Current	VCC = Min., I _{OL} = 8mA	—	0.4	V
V _{OH}	High-Level Output Current	VCC = Min., I _{OH} = -4mA	2.4	—	V
I _{OS} ⁽²⁾	Output Short-Circuit Current	VCC = Max., V _O = GND	-20	-90	mA
I _{HZ}	Off-State Output Current	VCC = Max., V _O = 2.4V	—	20	μA
I _{LZ}	(IDT72403 and IDT72404)	VCC = Max., V _O = 0.4V	-20	—	μA
I _{CC} ^(3, 4)	Supply Current	VCC = Max., f = 10MHz	—	35	mA
		Commercial	—	45	mA
		Military	—	45	mA

NOTES:

1. FIFO is able to withstand a -1.5V undershoot for less than 10ns.
2. Not more than one output should be shorted at a time and duration of the short-circuit should not exceed one second. Guaranteed but not tested.
3. I_{CC} measurements are made with outputs open. OE is HIGH for IDT72403/72404.
4. For frequencies greater than 10MHz, I_{CC} = 35mA + (1.5mA × [f - 10MHz]) commercial, and I_{CC} = 45mA + (1.5mA × [f - 10MHz]) military.

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OPERATING CONDITIONS

(Commercial: $V_{CC} = 5.0V \pm 10\%$, $T_A = 0^\circ C$ to $+70^\circ C$; Military: $V_{CC} = 5.0V \pm 10\%$, $T_A = -55^\circ C$ to $+125^\circ C$)

Symbol	Parameters	Figure	Commercial		Military and Commercial								Unit
			Min.	Max.	IDT72401L35		IDT72401L25		IDT72401L15		IDT72401L10		
					Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
tsH ⁽¹⁾	Shift in HIGH Time	2	9	—	9	—	11	—	11	—	11	—	ns
tsL	Shift in LOW Time	2	11	—	17	—	24	—	25	—	30	—	ns
tDS	Input Data Set-up	2	0	—	0	—	0	—	0	—	0	—	ns
tDH	Input Data Hold Time	2	13	—	15	—	20	—	30	—	40	—	ns
tSOH ⁽¹⁾	Shift Out HIGH Time	5	9	—	9	—	11	—	11	—	11	—	ns
tSOL	Shift Out LOW Time	5	11	—	17	—	24	—	25	—	25	—	ns
tMRW	Master Reset Pulse	8	20	—	25	—	25	—	25	—	30	—	ns
tMRS	Master Reset Pulse to SI	8	10	—	10	—	10	—	25	—	35	—	ns
tSIR	Data Set-up to IR	4	3	—	3	—	5	—	5	—	5	—	ns
tHIR	Data Hold from IR	4	13	—	15	—	20	—	30	—	30	—	ns
tSOR ⁽⁴⁾	Data Set-up to OR HIGH	7	0	—	0	—	0	—	0	—	0	—	ns

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AC ELECTRICAL CHARACTERISTICS

(Commercial: $V_{CC} = 5.0V \pm 10\%$, $T_A = 0^\circ C$ to $+70^\circ C$; Military: $V_{CC} = 5.0V \pm 10\%$, $T_A = -55^\circ C$ to $+125^\circ C$)

Symbol	Parameters	Figure	Commercial		Military and Commercial								Unit		
			Min.	Max.	IDT72401L45		IDT72401L35		IDT72401L25		IDT72401L15			IDT72401L10	
					IDT72402L45	IDT72402L35	IDT72402L25	IDT72402L15	IDT72402L10						
										IDT72403L45	IDT72403L35	IDT72403L25		IDT72403L15	IDT72403L10
IDT72404L45	IDT72404L35	IDT72404L25	IDT72404L15	IDT72404L10											
					Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
t _{IN}	Shift In Rate	2	—	45	—	35	—	25	—	15	—	10	MHz		
t _{IRL} ⁽¹⁾	Shift In to Input Ready LOW	2	—	18	—	18	—	21	—	35	—	40	ns		
t _{IRH} ⁽¹⁾	Shift In to Input Ready HIGH	2	—	18	—	20	—	28	—	40	—	45	ns		
t _{OUT}	Shift Out Rate	5	—	45	—	35	—	25	—	15	—	10	MHz		
t _{ORL} ⁽¹⁾	Shift Out to Output Ready LOW	5	—	18	—	18	—	19	—	35	—	40	ns		
t _{ORH} ⁽¹⁾	Shift Out to Output Ready HIGH	5	—	19	—	20	—	34	—	40	—	55	ns		
t _{ODH}	Output Data Hold (Previous Word)	5	5	—	5	—	5	—	5	—	5	—	ns		
t _{ODS}	Output Data Shift (Next Word)	5	—	19	—	20	—	34	—	40	—	55	ns		
t _{PT}	Data Throughput or "Fall-Through"	4, 7	—	30	—	34	—	40	—	65	—	65	ns		
t _{MRORL}	Master Reset to OR LOW	8	—	25	—	28	—	35	—	35	—	40	ns		
t _{MIRH}	Master Reset to IR HIGH	8	—	25	—	28	—	35	—	35	—	40	ns		
t _{MRO}	Master Reset to Data Output LOW	8	—	20	—	20	—	25	—	35	—	40	ns		
t _{OE} ⁽³⁾	Output Valid from \overline{OE} LOW	9	—	12	—	15	—	20	—	30	—	35	ns		
t _{HOE} ^(3,4)	Output HIGH-Z from \overline{OE} HIGH	9	—	12	—	12	—	15	—	25	—	30	ns		
t _{IPH} ^(2,4)	Input Ready Pulse HIGH	4	9	—	9	—	11	—	11	—	11	—	ns		
t _{OPH} ^(2,4)	Opout Ready Pulse HIGH	7	9	—	9	—	11	—	11	—	11	—	ns		

NOTES:

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- Since the FIFO is a very high-speed device, care must be exercised in the design of the hardware and timing utilized within the design. Device grounding and decoupling are crucial to correct operation as the FIFO will respond to very small glitches due to long reflective lines, high capacitances and/or poor supply decoupling and grounding. A monolithic ceramic capacitor of 0.1 μF directly between V_{CC} and GND with very short lead length is recommended.
- This parameter applies to FIFOs communicating with each other in a cascaded mode. IDT FIFOs are guaranteed to cascade with other IDT FIFOs of like speed grades.
- IDT72403 and IDT72404 only.
- Guaranteed by design but not currently tested.

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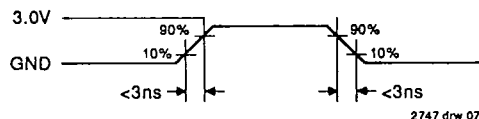
MILITARY AND COMMERCIAL TEMPERATURE RANGES

AC TEST CONDITIONS

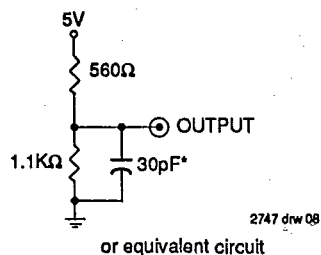
Input Pulse Levels	GND to 3.0V
Input Rise/Fall Times	3ns
Input Timing Reference Levels	1.5V
Output Reference Levels	1.5V
Output Load	See Figure 1

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ALL INPUT PULSES:



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or equivalent circuit

Figure 1. AC Test Load

*Including scope and jig

SIGNAL DESCRIPTIONS

INPUTS:

DATA INPUT (D0-3, 4)

Data input lines. The IDT72401 and IDT72403 have a 4-bit data input. The IDT72402 and IDT72404 have a 5-bit data input.

CONTROLS:

SHIFT IN (SI)

Shift In controls the input of the data into the FIFO. When SI is HIGH, data can be written to the FIFO via the D0-3, 4 lines.

SHIFT OUT (SO)

Shift Out controls the output of data of the FIFO. When SO is HIGH, data can be read from the FIFO via the Data Output (Q0-3, 4) lines.

MASTER RESET (\overline{MR})

Master Reset clears the FIFO of any data stored within. Upon power up, the FIFO should be cleared with a Master Reset. Master Reset is active LOW.

INPUT READY (IR)

When Input Ready is HIGH, the FIFO is ready for new input data to be written to it. When IR is LOW the FIFO is unavailable for new input data. Input Ready is also used to cascade many FIFOs together, as shown in Figures 10 and 11 in the Applications section.

OUTPUT READY (OR)

When Output Ready is HIGH, the output (Q0-3, 4) contains valid data. When OR is LOW, the FIFO is unavailable for new output data. Output Ready is also used to cascade many FIFOs together, as shown in Figures 10 and 11.

OUTPUT ENABLE (\overline{OE}) (IDT72403 AND IDT72404 ONLY)

Output enable is used to read FIFO data onto a bus. Output Enable is active LOW.

OUTPUTS:

DATA OUTPUT (Q0-3, 4)

Data Output lines. The IDT72401 and IDT72403 have a 4-bit data output. The IDT72402 and IDT72404 have a 5-bit data output.

FUNCTIONAL DESCRIPTION

These 64 x 4 and 64 x 5 FIFOs are designed using a dual port RAM architecture as opposed to the traditional shift register approach. This FIFO architecture has a write pointer, a read pointer and control logic, which allow simultaneous read and write operations. The write pointer is incremented by the falling edge of the Shift In (SI) control; the read pointer is incremented by the falling edge of the Shift Out (SO). The Input Ready (IR) signals when the FIFO has an available memory location; Output Ready (OR) signals when there is valid data on the output. Output Enable (\overline{OE}) provides the capability of three-stating the FIFO outputs.

FIFO Reset

The FIFO must be reset upon power up using the Master Reset (\overline{MR}) signal. This causes the FIFO to enter an empty state, signified by Output Ready (OR) being LOW and Input Ready (IR) being HIGH. In this state, the data outputs (Q0-3, 4) will be LOW.

Data Input

Data is shifted in on the LOW-to-HIGH transition of Shift In (SI). This loads input data into the first word location of the FIFO and causes Input Ready to go LOW. On the HIGH-to-LOW transition of Shift In, the write pointer is moved to the next word position and Input Ready (IR) goes HIGH, indicating the readiness to accept new data. If the FIFO is full, Input Ready will remain LOW until a word of data is shifted out.

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Data Output

Data is shifted out on the HIGH-to-LOW transition of Shift Out (SO). This causes the internal read pointer to be advanced to the next word location. If data is present, valid data will appear on the outputs and Output Ready (OR) will go HIGH. If data is not present, Output Ready will stay LOW indicating the FIFO is empty. The last valid word read from the FIFO will remain at the FIFO's output when it is empty. When the FIFO is not empty, Output Ready (OR) goes LOW on the LOW-to-HIGH transition of Shift Out. Previous data remains on the output until the HIGH-to-LOW transition of Shift Out (SO).

Fall-Through Mode

The FIFO operates in a fall-through mode when data gets shifted into an empty FIFO. After a fall-through delay the data propagates to the output. When the data reaches the output, the Output Ready (OR) goes HIGH. Fall-through mode also occurs when the FIFO is completely full. When data is shifted out of the full FIFO, a location is available for new data. After a fall-through delay, the Input Ready goes HIGH. If Shift In is HIGH, the new data can be written to the FIFO.

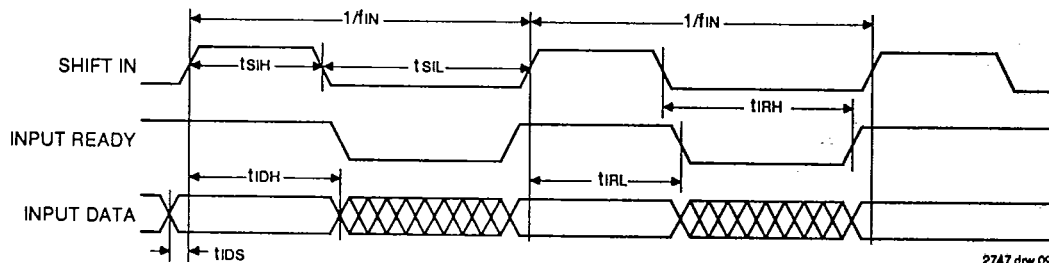
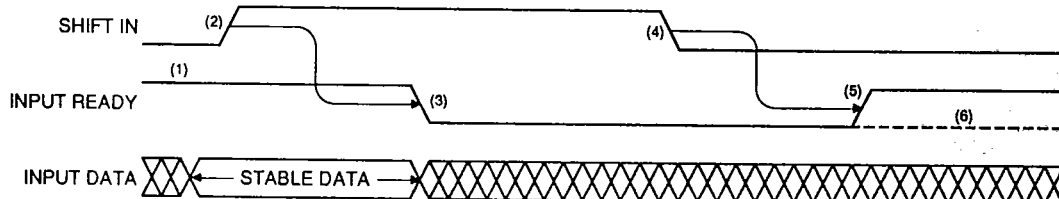
TIMING DIAGRAMS

Figure 2. Input Timing

**NOTES:**

1. Input Ready HIGH indicates space is available and a Shift In pulse may be applied.
2. Input Data is loaded into the first word.
3. Input Ready goes LOW indicating the first word is full.
4. The write pointer is incremented.
5. The FIFO is ready for the next word.
6. If the FIFO is full then the Input Ready remains LOW.

NOTE: Shift In pulses applied while Input Ready is LOW will be ignored (see Figure 4).

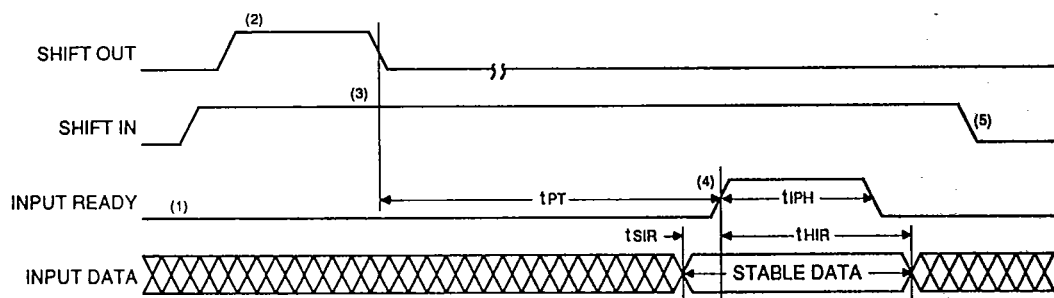
Figure 3. The Mechanism of Shifting Data Into the FIFO

IDT72401, IDT72402, IDT72403, IDT72404
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TIMING DIAGRAMS (Continued)

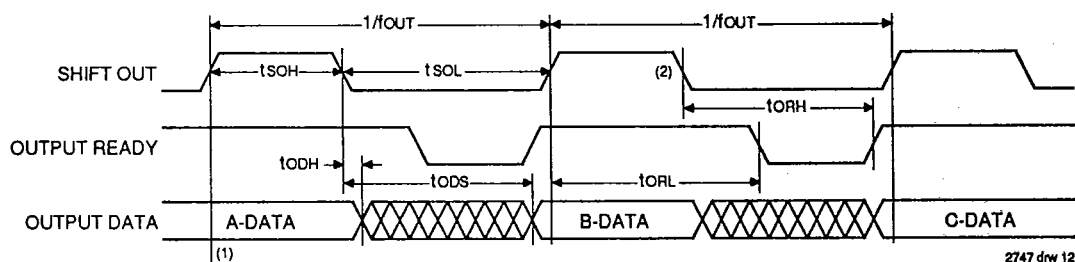
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NOTES:

1. FIFO is initially full.
2. Shift Out pulse is applied.
3. Shift In is held HIGH.
4. As soon as Input Ready becomes HIGH the Input Data is loaded into the FIFO.
5. The write pointer is incremented. Shift In should not go LOW until $(t_{PT} + t_{IPH})$.

Figure 4. Data Is Shifted In Whenever Shift In and Input Ready are Both HIGH



NOTES:

1. This data is loaded consecutively A, B, C.
2. Data is shifted out when Shift Out makes a HIGH to LOW transition.

Figure 5. Output Timing

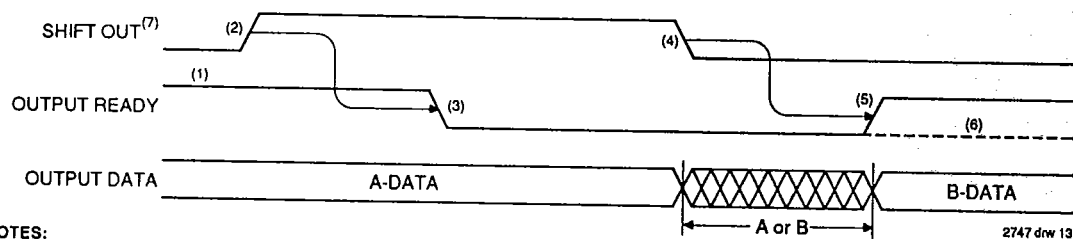
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TIMING DIAGRAMS (Continued)

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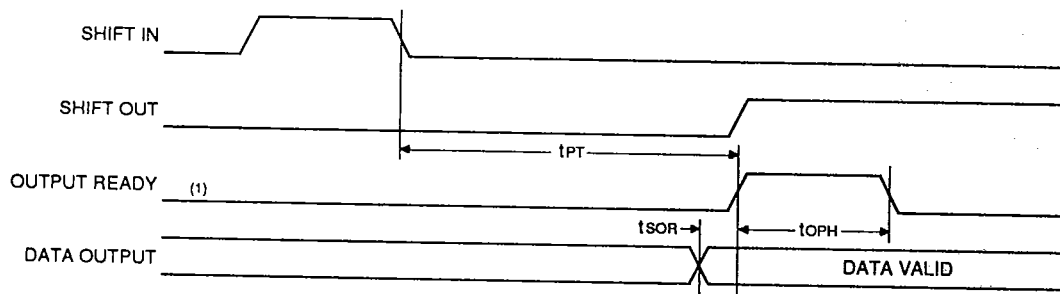


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NOTES:

1. Input Ready HIGH indicates that data is available and a Shift In pulse may be applied.
2. Shift Out goes HIGH causing the next step.
3. Output Ready goes LOW.
4. The read pointer is incremented.
5. Output Ready goes HIGH indicating that new data (B) is now available at the FIFO outputs.
6. If the FIFO has only one word loaded (A DATA) then Output Ready stays LOW and the A DATA remains unchanged at the outputs.
7. Shift Out pulses applied when Output Ready is LOW will be ignored.

Figure 6. The Mechanism of Shifting Data Out of the FIFO

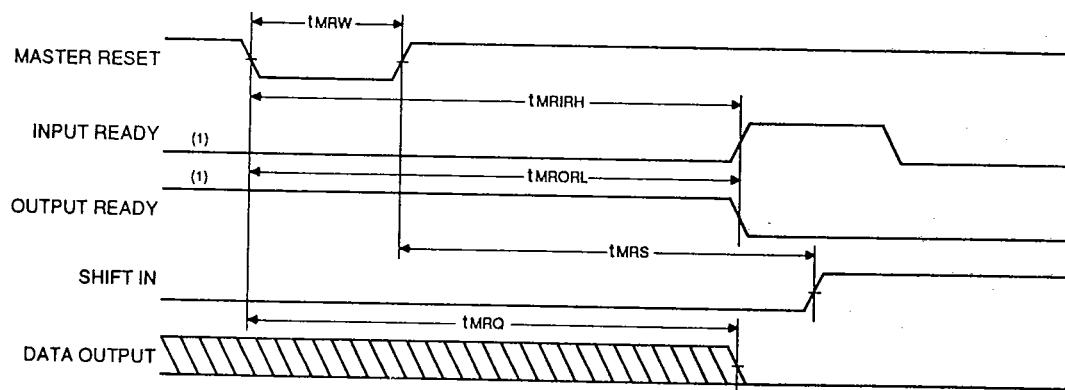


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NOTE:

1. FIFO initially empty.

Figure 7. tPT and tOPH Specification



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NOTE:

1. Worst case, FIFO initially full.

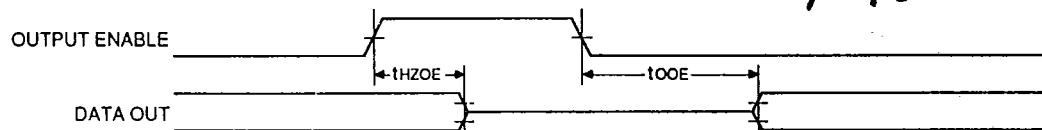
Figure 8. Master Reset Timing

IDT72401, IDT72402, IDT72403, IDT72404
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TIMING DIAGRAMS (Continued)

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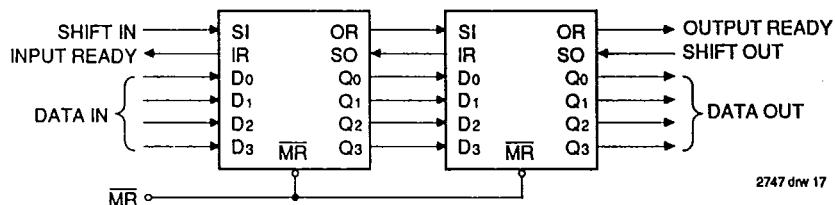
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NOTE:

- High-Z transitions are referenced to the steady-state V_{OH} -500mV and V_{OL} +500mV levels on the output. t_{HZOE} is tested with 5pF load capacitance instead of 30pF as shown in Figure 1.

Figure 9. Output Enable Timing, IDT72403 and IDT72404 Only

APPLICATIONS



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NOTE:

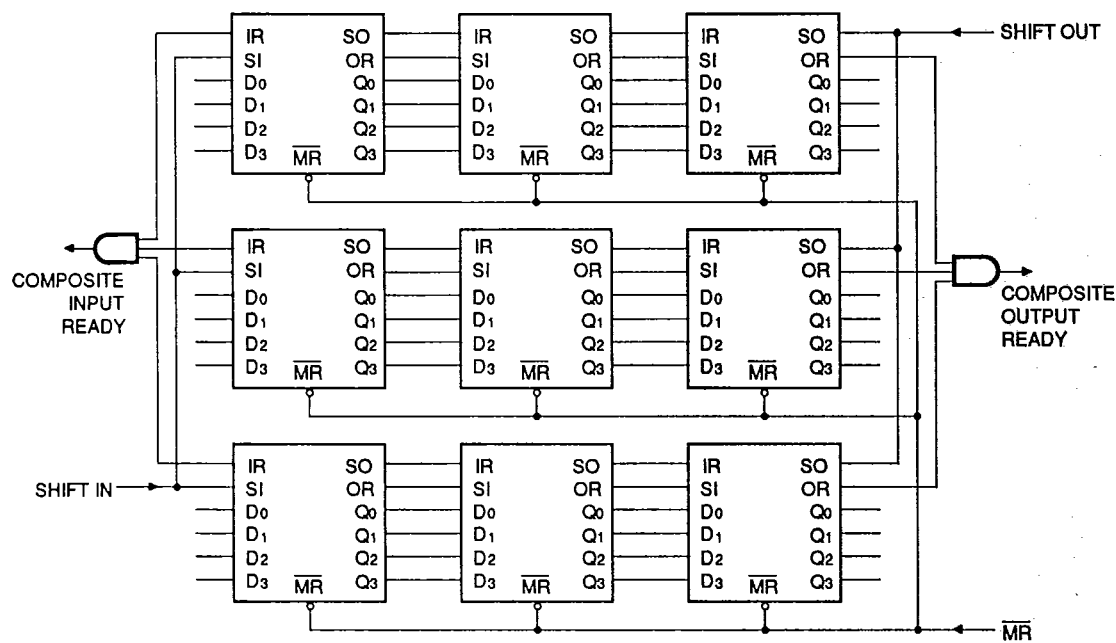
- FIFOs can be easily cascaded to any desired path. The handshaking and associated timing between the FIFOs are handled by the inherent timing of the devices.

Figure 10. 128 x 4 Depth Expansion

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NOTES:

1. When the memory is empty, the last word will remain on the outputs until the Master Reset is strobed or a new data word falls through to the output. However, OR will remain LOW, indicating data at the output is not valid.
2. When the output data changes as a result of a pulse on SO, the OR signal always goes LOW before there is any change in output data and stays LOW until the new data has appeared on the outputs. Anytime OR is HIGH, there is valid stable data on the outputs.
3. If SO is held HIGH while the memory is empty and a word is written into the input, that word will appear at the output after a fall-through time. OR will go HIGH for one internal cycle (at least four) and then go back LOW again. The stored word will remain on the outputs. If more words are written into the FIFO, they will line up behind the first word and will not appear on the outputs until SO has been brought LOW.
4. When the Master Reset is brought Low, the outputs are cleared to LOW, IR goes HIGH and OR goes LOW. If SI is HIGH when the Master Reset goes HIGH, the data on the inputs will be written into the memory and IR will return to the LOW state until SI is brought LOW. If SI is LOW when the Master Reset is ended, IR will go HIGH, but the data in the inputs will not enter the memory until SI goes HIGH.
5. FIFOs are expandable on depth and width. However, in forming wider words, two external gates are required to generate composite Input and Output Ready flags. This is due to the variation of delays of the FIFOs.

Figure 11. 192 x 12 Depth and Width Expansion

IDT72401, IDT72402, IDT72403, IDT72404
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ORDERING INFORMATION

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IDT	XXXXX	X	XX	X	X	
	Device Type	Power	Speed	Package	Process/ Temperature Range	
					Blank	Commercial (0°C to +70°C)
					B	Military (-55°C to + 125°C)
						Compliant to MIL-STD-883, Class B
					P	Plastic DIP
					SO	Small Outline IC
					D	CERDIP
					E	Cerpack (IDT72404 Only)
					45	Commercial Only
					35	} Shift Frequency (MHz)
					25	
					15	
					10	
					L	Low Power
					72401	64 x 4 FIFO
					72402	64 x 5 FIFO
					72403	64 x 4 FIFO with Output Enable
					72404	64 x 5 FIFO with Output Enable

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